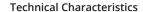
EMD1706QFN4 Driver Amplifier Module

DC-24 GHz GaAs PHEMT MMIC Driver Amplifier







Product Features

15.0 dB Gain @ 10 GHz

+23.0 dBm P1dB Output Power @ 10 GHz

+8V @ 130 mA typical supply voltage

Hermetically Sealed

Die available upon request

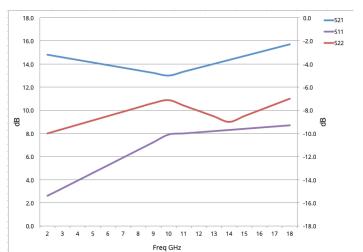
Eclipse Microdevices EMD1706QFN4 is a GaAs MMIC PHEMPT Distributed general purpose driver amplifier. This MMIC is ideal for applications that requires a typical P1dB output power of +23 dBm up to 20 GHz, while requiring only 130mA from a + 8 Volt supply. Gain flatness of this device is less than 0.8 dB from DC to 22 GHz. The EMD1706QFN4 comes in a small RoHS compliant 4mm QFN leadless package and has excellent RF and thermal properties ideal for commercial and industrial applications.

Electrical Specifications @ +25°C, Vdd=8V, Ids=130mA

Parameters	Freq. (GHz)	Min.	Typical	Max.	Units
Gain	2.0 10.0 18.0		14.8 13.0 15.7		dB dB dB
Gain Flatness	DC to 10.0 GHz 10.0 to 20.0		±0.20 ±0.45	±0.40 ±0.80	dB dB
Gain Variation Over Temperature				0.02	dB/°C
Noise Figure			6.5		dB
Input Return Loss	2.0 10.0 18.0		-15.4 -10.1 -15.6		dB dB dB
Output Return Loss	2.0 10.0 18.0		-16.8 -9.3 -9.7		dB
1dB Compression Point	2.0 8.0 14.0 20.0		23.0 22.5 22.0 21.0		dBm dBm dBm
Saturated Output Power	2.0 8.0 14.0 20.0		23.0 23.5 22.5 23.0		dBm dBm dBm
3rd Order Intercept Point			28.0		dBm

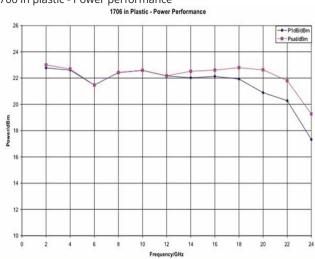
Note: Data taken from testing 529 parts (175 from ea. lot). Conditions: Vdd = +8 VDC, Vgg adjusted to set Idd = 130mA S21 can be increased by 0.5dB at each frequency by seting Idd = 150mA

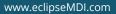
1706 in plastic - S-parameters



Quality products that serve the industry. Today and tomorrow.

1706 in plastic - Power performance





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Absolute Maximum Rating

RF Input Power: +18 dBm Drain Voltage(Vdd): +8.0 VDC Gate Voltage(Vgg): -2 to 0 Volts Max Tj 85°C: +110°C

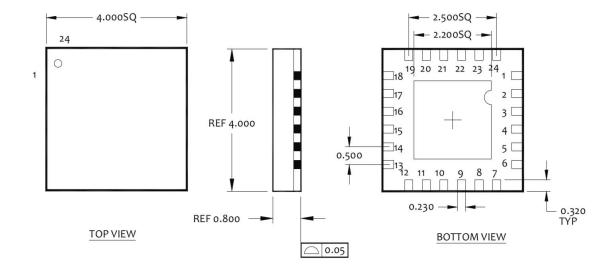
Storage Temp:

Operating Temp:

NC -55 to +150°C -40 to +85°C NC GND RF-IN o 1706 RECOMMENDED PCB LAYOUT GND NC ACG4 NC ACG₃ Vgg1 .032 [0.80] SQ .105 [2.68] 0 0

1. MATERIAL: ROGERS 4350, 10 MIL THICK 2, DIMENSIONS ARE IN INCHES[MM]

.010 GAF [0.25]



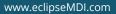
About EclipseMDI

: INPUT

0 0

PAD WIDTH

ECLIPSE Microdevices is located in San Jose, California. ECLIPSE has been developing high performance analog semiconductors for use in wireless radio frequency (RF), microwave, and millimeter wave for commercial and industrial applications. ECLIPSE has formed a strategic alliances - with foundries that features leading state-of-the-art process technologies and with manufacturing facilities for high-volume production of innovative RFIC's.



Functional Block Diagram

NC ACG2

20

19

18

17

NC

GND

GND

NC

o RF-OUT & Vdd

ACG1

Vgg2